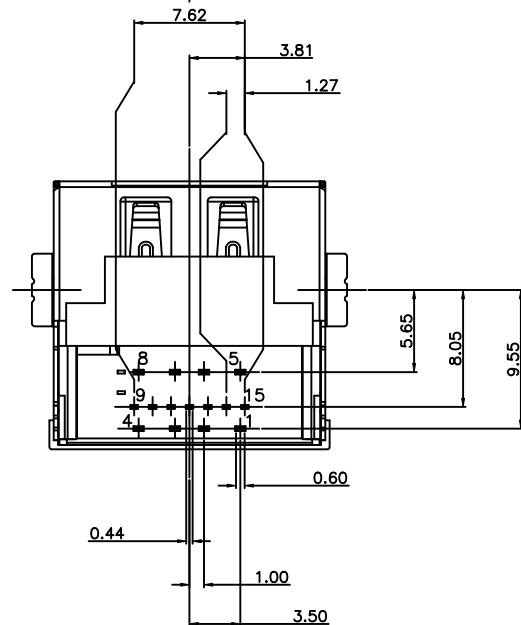
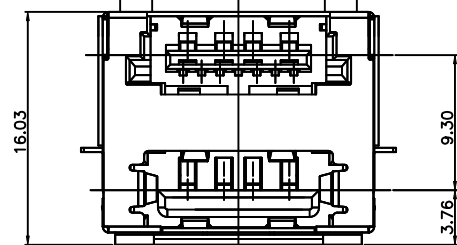
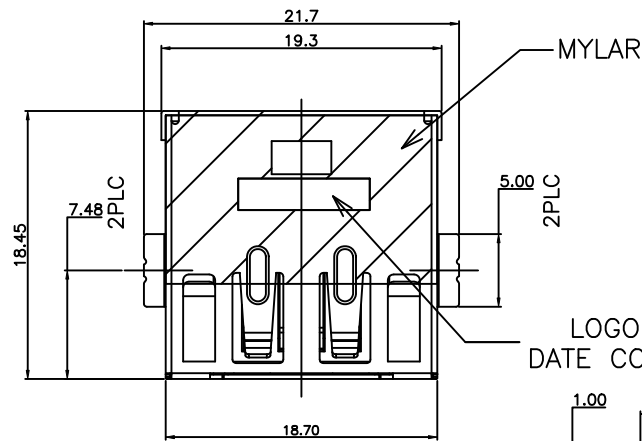




NOTES:

1.MATERIAL:

HOUSING:THERMOPLASTIC, HIGH TEMP, 30% G/F UL94 V-0
COLOR:BLACK
SPACER:THERMOPLASTIC, HIGH TEMP, 30% G/F UL94 V-0
COLOR:BLACK
FRONT SHELL:COPPER ALLOY
GROUNDING STRIP:STEEL
ESATA CONTACT:COPPER ALLOY
USB CONTACT:COPPER ALLOY
DETECT PIN:COPPER ALLOY
LATCH:STEEL

2.FINISH:

CONTACT:GOLD PLATING ON CONTACT AREA
2.54um[100u"] MIN. MATT TIN PLATING ON SOLDER TAILS
1.27um[50u"] MIN. NICKEL UNDERPLATING OVER ALL
FRONT SHELL:2.54um[100u"] MIN.NICKEL UNDERPLATING OVERALL

3. THE HOUSING WILL WITHSTAND EXPOSURE TO 260 C TEMP.
FOR 10 SECOND IN A WAVE SOLDER APPLICATION WITH
A 1.6MM MIN. THICK CIRCUIT BOARD.

4. PRODUCT GS-12-402

PACKING SPEC: GS-14-1099

5. NUMBERING INFORMATION

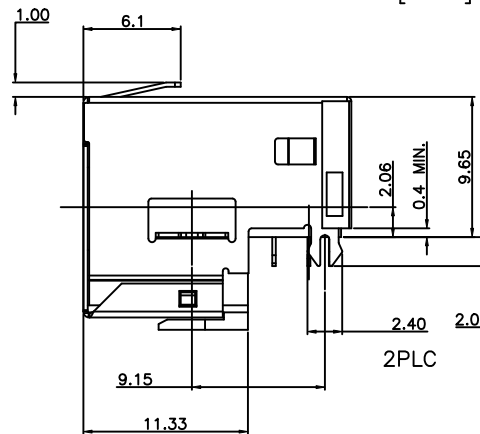
10100446 - 0 0 X X LF

— LEAD FREE

— BLANK: TRAY PACKING
R : TAPE & REEL PACKING

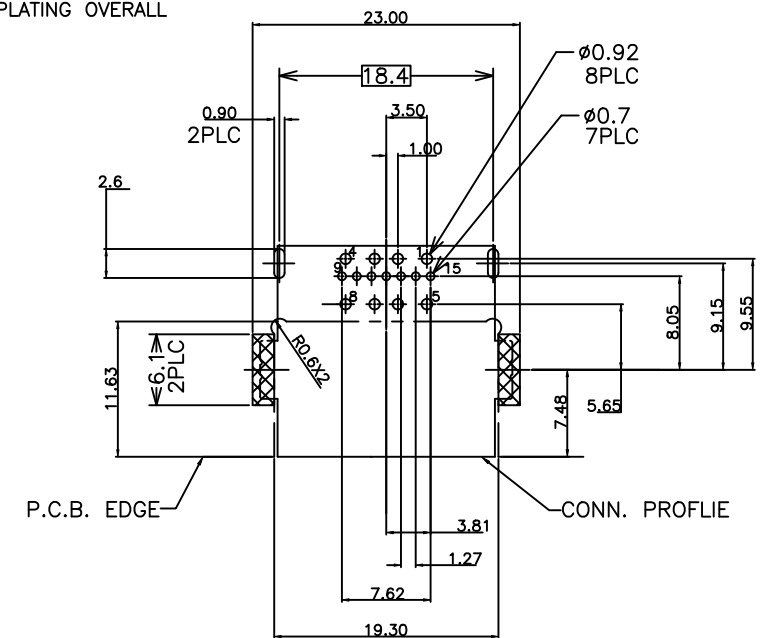
1 - 15u" GOLD PLATING
— 3 - 30u" GOLD PLATING

LOGO
DATE CODE



USB TOP		ESATA	
NAME	TYPE	NAME	TYPE
P1	VBUS	P9	GND
P2	D-	P10	A+
P3	D+	P11	A-
P4	GND	P12	GND
		P13	B-
		P14	B+
		P15	GND

USB BOTTOM	
NAME	TYPE
P5	VBUS
P6	D-
P7	D+
P8	GND



REFERENCE P.C.BOARD LAYOUT T=1.60mm
PCB TOLERANCE:±0.05

[illegible]